

HD68P05V05, HD68P05V07 MCU (Microcomputer Unit)

—PRELIMINARY—

The HD68P05V is the 8-bit Microcomputer Unit (MCU) which contains a CPU, on-chip clock, RAM, I/O and timer. It is designed for the user who needs an economical microcomputer with the proven capabilities of the HD6800-based instruction set. Setting EPROM on the package, this MCU has the equivalent function as the HD6805U and HD6805V. HD68P05V05 uses HN462532 as EPROM. HD68P05V07 uses HN462732 as EPROM. The following are some of the hardware and software highlights of the MCU.

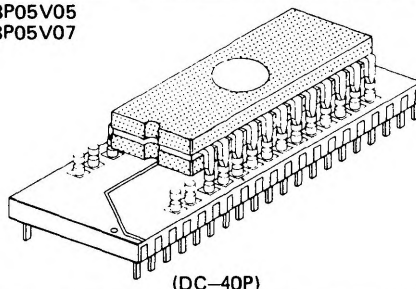
■ HARDWARE FEATURES

- 8-Bit Architecture
- 96 Bytes of RAM
- Memory Mapped I/O
- Internal 8-Bit Timer with 7-Bit Prescaler
- Vectored Interrupts — External, Timer and Software
- 24 I/O Ports + 8 Input Port
(8 Lines LED Compatible; 7 Voltage Comparator Inputs)
- On-Chip Clock Circuit
- Master Reset
- Complete Development System Support by Evaluation Kit
- 5 Vdc Single Supply

■ SOFTWARE FEATURES

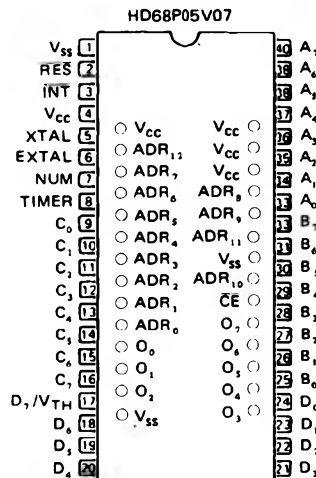
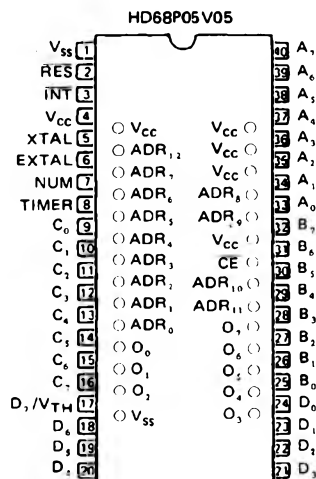
- Similar to HD6800
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to ROM, RAM and I/O
- Compatible Instruction Set with HD6805

HD68P05V05
HD68P05V07

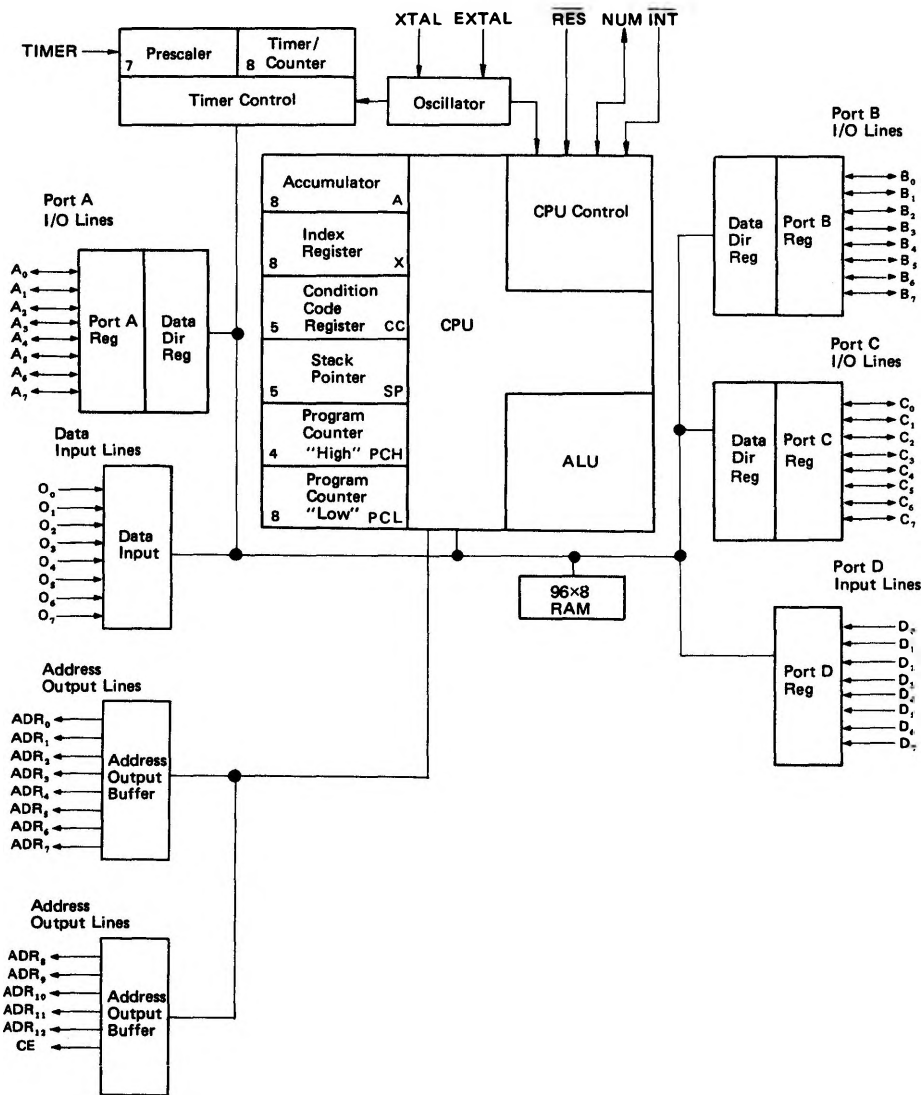


(DC-40P)

■ PIN ARRANGEMENT (Top View)



■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage (EXCEPT TIMER)	V_{in}^*	-0.3 ~ +7.0	V
Input Voltage (TIMER)		-0.3 ~ +12.0	V
Operating Temperature	T_{opr}	0 ~ +70	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5.25V \pm 0.5V$, $V_{SS}=GND$, $T_a=0 \sim +70^\circ C$, unless otherwise noted.)

Item		Symbol	Test Condition	min	typ	max	Unit
Input "High" Voltage	RES	V_{IH}		4.0	—	V_{CC}	V
	INT			3.0	—	V_{CC}	V
	All Other			2.0	—	V_{CC}	V
Input "Low" Voltage	RES	V_{IL}		-0.3	—	0.8	V
	INT			-0.3	—	0.8	V
	XTAL (Crystal Mode)			-0.3	—	0.6	V
	All Other			-0.3	—	0.8	V
Power Dissipation		P_D		—	400	700	mW
Low Voltage Recover		LVR		—	—	4.75	V
Input Leak Current	TIMER	I_{IL}	$V_{in}=0.4V \sim V_{CC}$	-20	—	20	μA
	INT			-50	—	50	μA
	XTAL (Crystal Mode)			-1200	—	0	μA

● AC CHARACTERISTICS ($V_{CC}=5.25V \pm 0.5V$, $V_{SS}=GND$, $T_a=0 \sim +70^\circ C$, unless otherwise noted.)

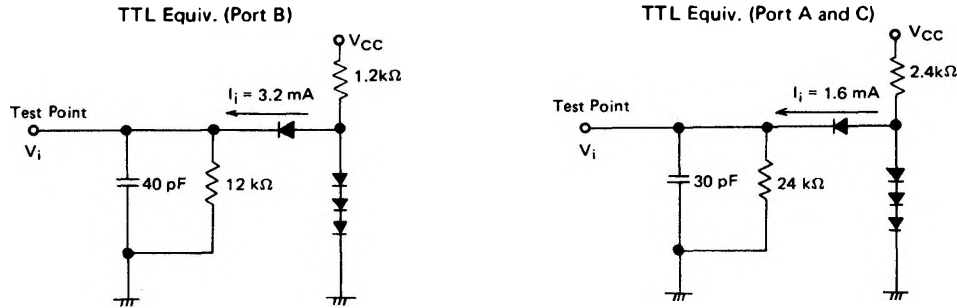
Item		Symbol	Test Condition	min	typ	max	Unit
Clock Frequency		f_{cl}		0.4	—	4.0	MHz
Cycle Time		t_{cyc}		1.0	—	10	μs
INT Pulse Width		t_{IWL}		$t_{cyc} + 250$	—	—	ns
RES Pulse Width		t_{RWL}		$t_{cyc} + 250$	—	—	ns
TIMER Pulse Width		t_{TWL}		$t_{cyc} + 250$	—	—	ns
Oscillation Start-up Time (Crystal Mode)		t_{osc}	$C_L=22pF \pm 20\%$, $R_S=60\Omega$ max.	—	—	100	ms
Delay Time Reset		t_{RHL}	External Cap. = 2.2 μF	100	—	—	ms
Input Capacitance	EXTAL	C_{in}	$V_{in}=0V$	—	25	35	pF
	All Other			—	6	10	pF

HD68PO5VO5, HD68PO5VO7

● PORT ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.25V \pm 0.5V$, $V_{SS} = GND$, $T_a = 0 \sim +70^{\circ}C$ unless otherwise noted.)

Item		Symbol	Test Condition	min	typ	max	Unit
Output “High” Voltage	Port A	V _{OH}	I _{OH} = −10 μA	3.5	—	—	V
			I _{OH} = −100 μA	2.4	—	—	V
	Port B		I _{OH} = −200 μA	2.4	—	—	V
			I _{OH} = −1 mA	1.5	—	—	V
	Port C		I _{OH} = −100 μA	2.4	—	—	V
Output “Low” Voltage	Port A and C	V _{OL}	I _{OL} = 1.6 mA	—	—	0.4	V
	Port B		I _{OL} = 3.2 mA	—	—	0.4	V
			I _{OL} = 10 mA	—	—	1.0	V
Input “High” Voltage	Port A, B, C, and D*	V _{IH}	2.0	—	V _{CC}	V	
Input “Low” Voltage		V _{IL}	−0.3	—	0.8	V	
Input Leak Current	Port A	I _{IL}	V _{in} = 0.8V	−500	—	—	μA
			V _{in} = 2V	−300	—	—	μA
	Port B, C, and D		V _{in} = 0.4V ~ V _{CC}	− 20	—	20	μA
Input “High” Voltage	Port D** (D ₀ ~ D ₆)	V _{IH}	—	V _{TH} +0.2	—	V	
Input “Low” Voltage	Port D** (D ₀ ~ D ₆)	V _{IL}	—	V _{TH} -0.2	—	V	
Threshold Voltage	Port D**(D ₇)	V _{TH}	0	—	0.8×V _{CC}	V	

* Port D as digital input
** Port D as analog input



(NOTE) 1. Load capacitance includes the floating capacitance of the probe and the jig etc.
2. All diodes are 1S2074 (H) or equivalent.

Figure 1 Bus Timing Test Loads

● SIGNAL DESCRIPTION

The input and output signals for the MCU shown in PIN ARRANGEMENT are described in the following paragraphs.

● V_{CC} and V_{SS}

Power is supplied to the MCU using these two pins. V_{CC} is $+5.25V \pm 0.5V$. V_{SS} is the ground connection.

● INT

This pin provides the capability for applying an external interrupt to the MCU. Refer to INTERRUPTS for additional information.

● XTAL and EXTAL

These pins provide control input for the on-chip clock circuit. A crystal (AT cut, 4 MHz maximum) can be connected to these pins to provide the internal oscillator with varying degrees of stability. Refer to INTERNAL OSCILLATOR

for recommendations about these inputs.

● TIMER

This pin allows an external input to be used to decrement the internal timer circuitry. Refer to TIMER for additional information about the timer circuitry.

● RES

This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. Refer to RESETS for additional information.

● NUM

This pin is not for user application and should be connected to ground.

Input/Output Lines ($A_0 \sim A_7$, $B_0 \sim B_7$, $C_0 \sim C_7$)

These 24 lines are arranged into three 8-bit ports (A, B and C). All lines are programmable as either inputs or outputs under software control of the data direction registers. Refer to INPUTS/OUTPUTS for additional information.

Input Lines ($D_0 \sim D_7$)

These are 8-bit input lines, which has two functions. Firstly, these become TTL compatible inputs, by reading \$003 address. The other function of them is 7 Voltage comparators, by reading \$007 address. Please refer to INPUT PORT for more detail.

REGISTERS

The MCU has five registers available to the programmer. They are shown in Figure 2 and are explained in the following paragraphs.

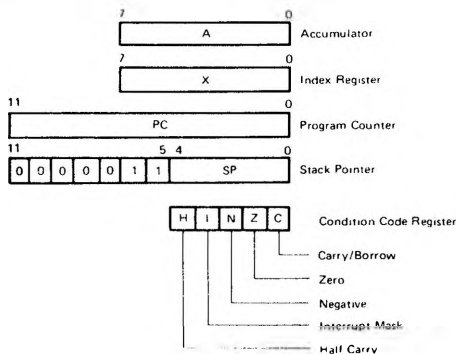


Figure 2 Programming Model

Accumulator (A)

The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

Index Register (X)

The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit address that may be added to an offset value to create an effective address. The index register can also be used for limited calculations and data manipulations when using read/modify/write instructions. When not required by a code sequence being executed, the index register can be used as a temporary storage area.

Program Counter (PC)

The program counter is a 13-bit register that contains the address of the next instruction to be executed.

Stack Pointer (SP)

The stack pointer is a 13-bit register that contains the address of the next free location on the stack. Initially, the stack pointer is set to location \$007F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack. The six most significant bits of the stack pointer are permanently set to 0000011. During an MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set to location \$007F. Subroutines and interrupts may be nested down to location \$0061 which allows the programmer to use up to 15 levels of subroutine calls.

Condition Code Register (CC)

The condition code register is a 5-bit register in which each bit is used to indicate or flag the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each individual condition code register bit is explained in the following paragraphs.

Half Carry (H)

Used during arithmetic operations (ADD and ADC) to indicate that a carry occurred between bits 3 and 4.

Interrupt (I)

This bit is set to mask the timer and external interrupt (INT). If an interrupt occurs while this bit is set it is latched and will be processed as soon as the interrupt bit is reset.

Negative (N)

Used to indicate that the result of the last arithmetic, logical or data manipulation was negative (bit 7 in result equal to a logical one).

Zero (Z)

Used to indicate that the result of the last arithmetic, logical or data manipulation was zero.

Carry/Borrow (C)

Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions, shifts, and rotates.

TIMER

The MCU timer circuitry is shown in Figure 3. The 8-bit counter is loaded under program control and counts down toward zero as soon as the clock input is applied. When the timer reaches zero the timer interrupt request bit (bit 7) in the timer control register is set. The MCU responds to this interrupt by saving the present MCU state in the stack, fetching the timer interrupt vector from locations \$0FF8 and \$0FF9 and executing the interrupt routine. The timer interrupt can be masked by setting the timer interrupt mask bit (bit 6) in the time control

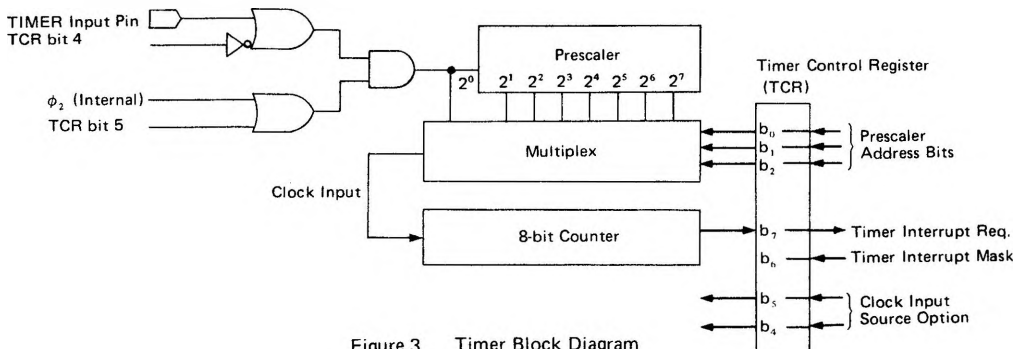


Figure 3 Timer Block Diagram

register. The interrupt bit (I bit) in the condition code register will also prevent a timer interrupt from being processed.

The clock input to the timer can be from an external source applied to the TIMER input pin or it can be the internal ϕ_2 signal. Note that when the ϕ_2 signal is used as the source it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulse-width measurements. A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before being applied to the counter. The timer continues to count past zero and its present count can be monitored at any time by monitoring the timer data register. This allows a program to determine the length of time since a timer interrupt has occurred and not disturb the counting process.

The timer data register is 8-bit read/write register with address \$008 on memory-map. This timer data register and the prescaler are initialize with all logical ones at reset time.

The timer interrupt request bit (bit 7 of timer control register) is set to one by hardware when timer count reaches zero, and is cleared by program or by hardware reset. The bit 6 of timer control register is writable by program. Both of those bits can be read by MPU.

The bit 5 and bit 4 of the timer control register is a clock input source. The combinations are shown in Table 1. The bit 3 is not used. The bit 2, bit 1 and bit 0 are used to select a dividing ratio of the prescaler. The options of the dividing ratio are shown in Table 2. An internal clock is selected as a clock input source and the dividing ratio of a prescaler is set at "Bypass Prescaler" at reset time.

Table 1 Clock Input Source Option

Timer Control Register (TCR)		Clock Input Source
b ₅	b ₄	
0	1	ϕ_2 (Internal Clock)
1	1	TIMER Input Pin

Table 2 Prescaler Dividing Ratio Option

Timer Control Register (TCR)			Prescaler Dividing Ratio
b ₂	b ₁	b ₀	
0	0	0	Bypass Prescaler
0	0	1	Prescaler ÷ 2
0	1	0	Prescaler ÷ 4
0	1	1	Prescaler ÷ 8
1	0	0	Prescaler ÷ 16
1	0	1	Prescaler ÷ 32
1	1	0	Prescaler ÷ 64
1	1	1	Prescaler ÷ 128

■ RESETS

The MCU can be reset three ways: by initial powerup, by the external reset input (RES) and by an internal low voltage detect circuit (mask option) see Figure 4. All the I/O port are

initialized to Input mode (DDR's are cleared) during RESET.

Upon power up, a minimum of 100 milliseconds is needed before allowing the reset input to go "High".

This time allows the internal crystal oscillator to stabilize. Connecting a capacitor to the RES input as shown in Figure 5 will provide sufficient delay.

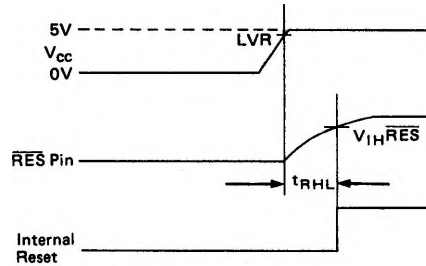


Figure 4 Power and RES Timing

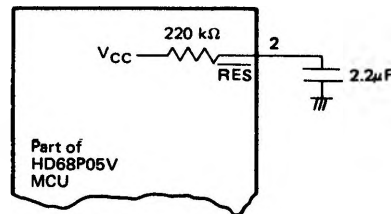


Figure 5 Power Up Reset Delay Circuit

■ INTERNAL OSCILLATOR

The internal oscillator circuit has been designed to require a minimum of external components. The use of a crystal (AT cut, 4 MHz max) is sufficient to drive the internal oscillator with varying degrees of stability. The different connection methods are shown in Figure 6. Crystal specifications are given in Figure 7.

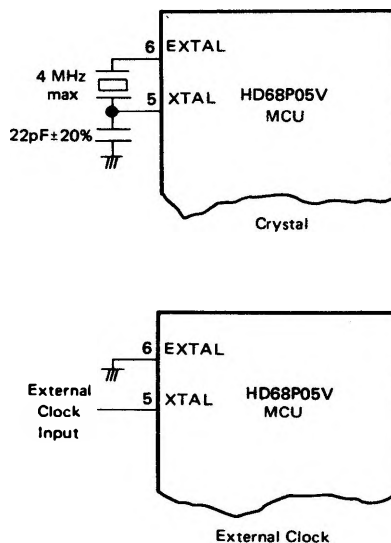
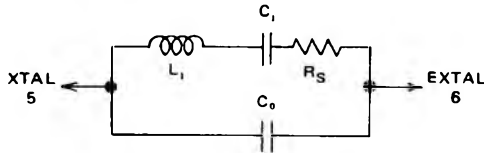


Figure 6 Internal Oscillator



AT – Cut Parallel Resonance Crystal
 $C_0 = 7 \text{ pF max.}$
 $f = 4 \text{ MHz}$
 $R_S = 60 \Omega \text{ max.}$

Figure 7 Crystal Parameters

■ INTERRUPTS

The MCU can be interrupted three different ways: through the external interrupt (INT) input pin, the internal timer interrupt request, and a software interrupt instruction (SWI). When any interrupt occurs, processing is suspended, the present MCU state is pushed onto the stack in the order shown in Fig. 8, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. Since the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first; then the high order five bits (PCH) are stacked. This ensures that the program counter is loaded correctly as the stack pointer increments when it pulls data from the stack. A subroutine call will cause only

the program counter (PCH, PCL) contents to be pushed onto the stack. This interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. The interrupt service routines normally end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt. Table 3 provides a listing of the interrupts, their priority, and the vector address that contain the starting address of the appropriate interrupt routine.

A flowchart of the interrupt processing sequence is given in Fig. 9.

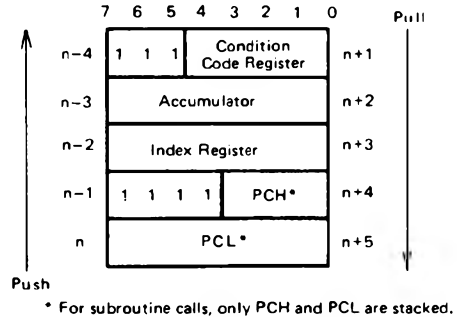


Figure 8 Interrupt Stacking Order

Table 3 Interrupt Priorities

Interrupt	Priority	Vector Address
RES	1	\$0FFE and \$0FFF
SWI	2	\$0FFC and \$0FFD
INT	3	\$0FFA and \$0FFB
TIMER	4	\$0FF8 and \$0FF9

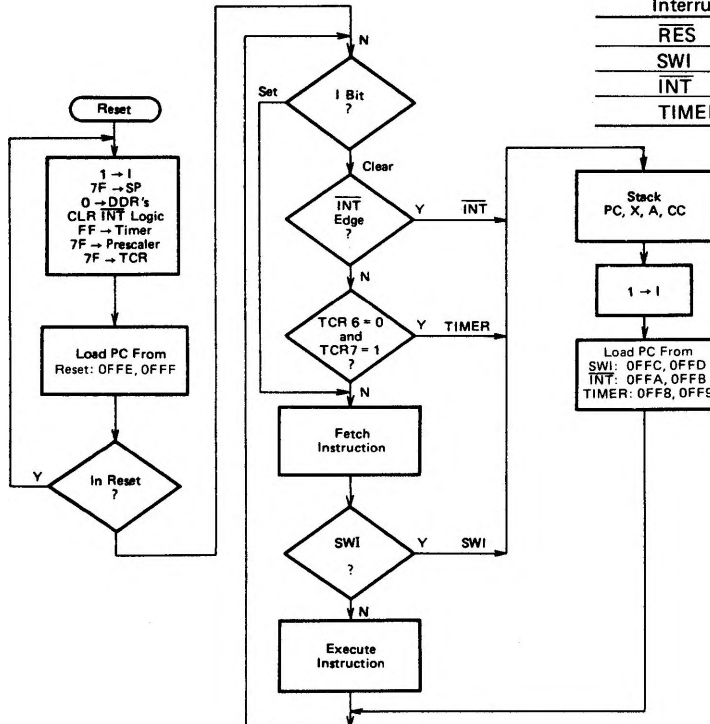


Figure 9 Interrupt Processing Flowchart

■ INPUT/OUTPUT

There are 24 input/output pins. All pins are programmable as either inputs or outputs under software control of the data direction registers. When programmed as outputs, all I/O pins read latched output data regardless of the logic level at the output pin due to output loading (see Fig. 10). When port B is

programmed for outputs, it is capable of sinking 10 millamperes on each pin ($V_{OL} = 1V$ max). All input/output lines are TTL compatible as both inputs and outputs. Port A lines are CMOS compatible as outputs while port B and C lines are CMOS compatible as inputs. Figure 11 provides some examples of port connections.

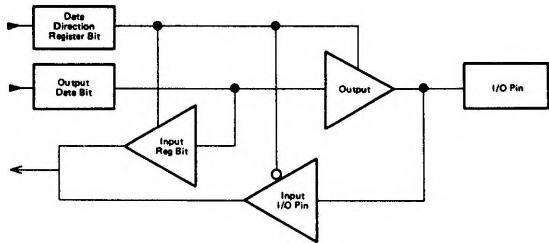
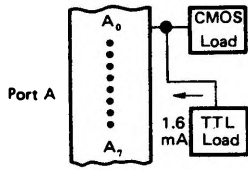
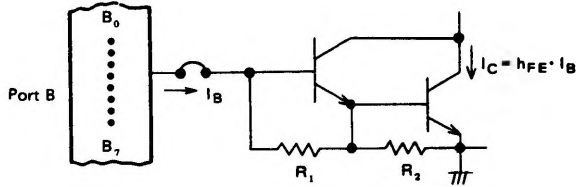


Figure 10 Typical Port I/O Circuitry

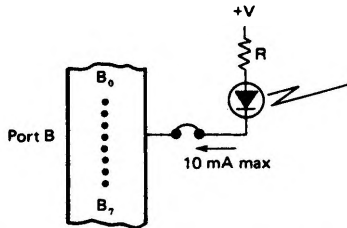
Data Direction Register Bit	Output Data Bit	Output State	Input to MCU
1	0	0	0
1	1	1	1
0	×	3-State	Pin



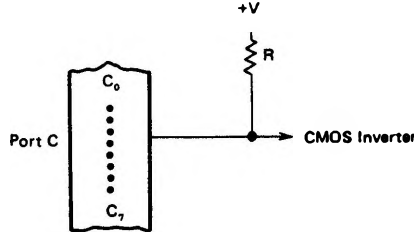
Port A Programmed as output(s) driving CMOS and TTL Load directly.
(a)



Port B Programmed as output(s) driving Darlington base directly.
(b)



Port B Programmed as output(s) driving LED(s) directly.
(c)



Port C Programmed as output(s) driving CMOS using external pull-up resistors.
(d)

Figure 11 Typical Port Connections

■ INPUT

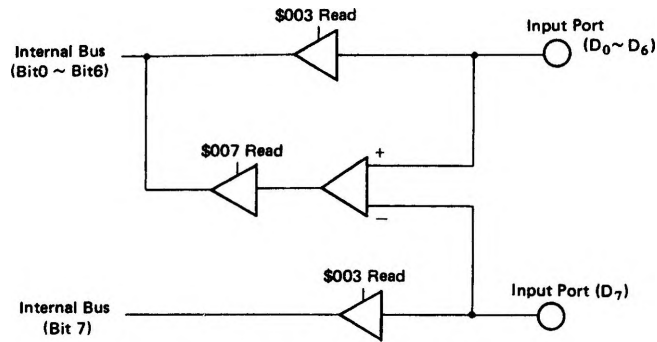
Port D is 8-bit input port, which has two functions. One of them is usual digital signal input port and the other is voltage compare type input port. In the former case, the input data can be read by MPU at \$003 address. In the latter case, D7 (pin 17) is the input pin of V_{TH} (reference level), and the other seven input pins ($D_0 \sim D_6$) are analog level inputs, which are compared with V_{TH} (see Figure 12(a), (b)).

"1" or "0" signals appear at internal data bus, if the input levels are higher or lower respectively when \$007 address is read. This function is effective in such case that unusual logic level inputs are used. A capacitive touch panel interface and a diode isolated keyboard interface are the examples. Figure 12(c) shows the application of Port D to A/D converter, and Figure 12(d) shows 3 levels inputs.

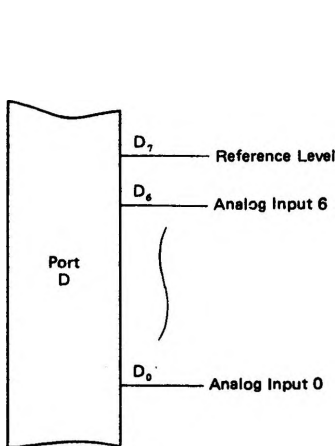
■ BIT MANIPULATION

The MCU has the ability to set or clear any single random access memory or input/output bit (except the data direction registers) with a single instruction (BSET, BCLR). Any bit in the page zero read only memory can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. This capability to work with any bit in RAM, ROM or I/O allows the user to have individual flags in RAM or to handle single I/O bits as control lines. The example in Figure 13 illustrates the usefulness of the bit manipulation and test instructions. Assume that bit 0 of port A is connected to a zero crossing detector circuit and that bit 1 of port A is connected to the trigger of a TRIAC which power the controlled hardware.

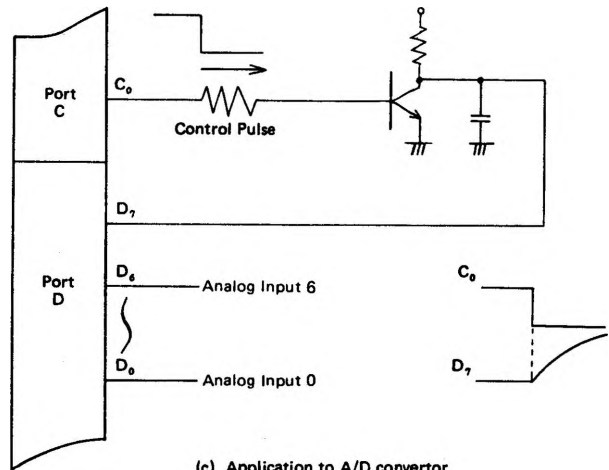
This program, which uses only seven ROM locations, provides turn-on of the TRIAC within 14 microseconds of the zero crossing. The timer could also be incorporated to provide turn-on at some later time which would permit pulse-width modulation of the controlled power.



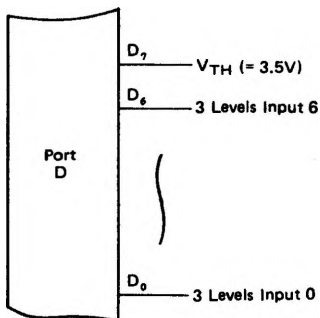
(a) The logic configuration of Port D



(b) Seven analog inputs and a reference level input of Port D



(c) Application to A/D convertor



(d) Application to 3 levels input

Input Voltage	(\$003)	(\$007)
0V ~ 0.8V	0	0
2.0V ~ 3.3V	1	0
3.7V ~ V _{CC}	1	1

Figure 12 Configuration and Application of Port D

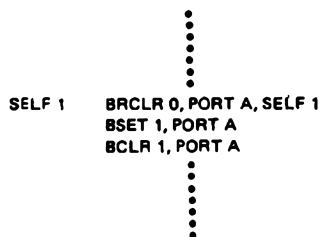


Figure 13 Bit Manipulation Example

■ ADDRESSING MODES

The MCU has ten addressing modes available for use by the programmer. They are explained and illustrated briefly in the following paragraphs.

● Immediate

Refer to Figure 14. The immediate addressing mode accesses constants which do not change during program execution. Such instructions are two bytes long. The effective address (EA) is the PC and the operand is fetched from the byte following the opcode.

● Direct

Refer to Figure 15. In direct addressing, the address of the operand is contained in the second byte of the instruction. Direct addressing allows the user to directly address the lowest 256 bytes in memory. All RAM space, I/O registers and 128 bytes of ROM are located in page zero to take advantage of this efficient memory addressing mode.

● Extended

Refer to Figure 16. Extended addressing is used to reference any location in memory space. The EA is the contents of the two bytes following the opcode. Extended addressing instructions are three bytes long.

● Relative

Refer to Figure 17. The relative addressing mode applies only to the branch instructions. In this mode the contents of the byte following the opcode is added to the program counter when the branch is taken. $EA = (PC) + 2 + Rel$. Rel is the contents of the location following the instruction opcode with bit 7 being the sign bit. If the branch is not taken Rel=0, when a branch takes place, the program goes to somewhere within the range of +129 bytes to -127 of the present instruction. These instructions are two bytes long.

● Indexed (No Offset)

Refer to Figure 18. This mode of addressing accesses the lowest 256 bytes of memory. These instructions are one byte long and their EA is the contents of the index register.

● Indexed (8-bit Offset)

Refer to Figure 19. The EA is calculated by adding the contents of the byte following the opcode to the contents of the index register. In this mode, 511 low memory locations are accessible. These instructions occupy two bytes.

● Indexed (16-bit Offset)

Refer to Figure 20. This addressing mode calculates the EA by adding the contents of the two bytes following the opcode to the index register. Thus, the entire memory space may be accessed. Instructions which use this addressing mode are three bytes long.

● Bit Set/Clear

Refer to Figure 21. This mode of addressing applies to instructions which can set or clear any bit on page zero. The lower three bits in the opcode specify the bit to be set or cleared while the byte following the opcode specifies the address in page zero.

● Bit Test and Branch

Refer to Figure 22. This mode of addressing applies to instructions which can test any bit in the first 256 locations (\$00-\$FF) and branch to any location relative to the PC. The byte to be tested is addressed by the byte following the opcode. The individual bit within that byte to be tested is addressed by the lower three bits of the opcode. The third byte is the relative address to be added to the program counter if the branch condition is met. These instructions are three bytes long. The value of the bit tested is written to the carry bit in the condition code register.

● Implied

Refer to Figure 23. The implied mode of addressing has no EA. All the information necessary to execute an instruction is contained in the opcode. Direct operations on the accumulator and the index register are included in this mode of addressing. In addition, control instructions such as SWI, RTI belong to this group. All implied addressing instructions are one byte long.

■ INSTRUCTION SET

The MCU has a set of 59 basic instructions. They can be divided into five different types: register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

● Register/Memory Instructions

Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 4.

● Read/Modify/Write Instructions

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to the read/modify/write instructions since it does not perform the write. Refer to Table 5.

● Branch Instructions

The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 6.

● Bit Manipulation Instructions

These instructions are used on any bit in the first 256 bytes of the memory. One group either sets or clears. The other group performs the bit test and branch operations. Refer to Table 7.

● Control Instructions

The control instructions control the MCU operations during program execution. Refer to Table 8.

● Alphabetical Listing

The complete instruction set is given in alphabetical order in Table 9.

● Opcode Map

Table 10 is an opcode map for the instructions used on the MCU.

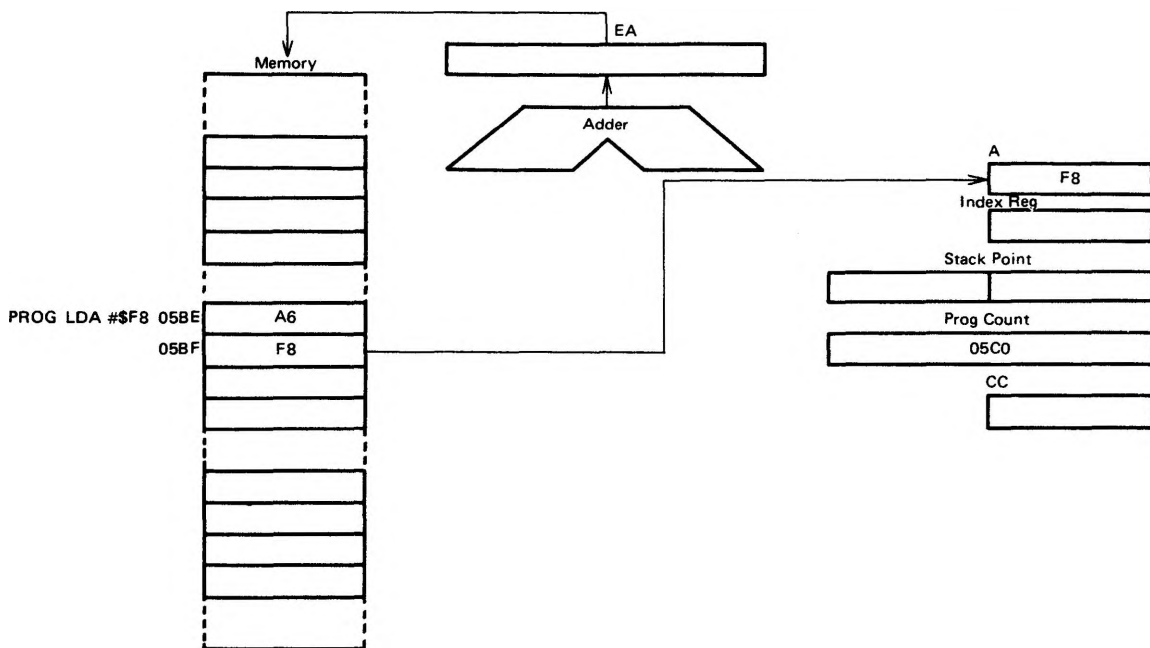


Figure 14 Immediate Addressing Example

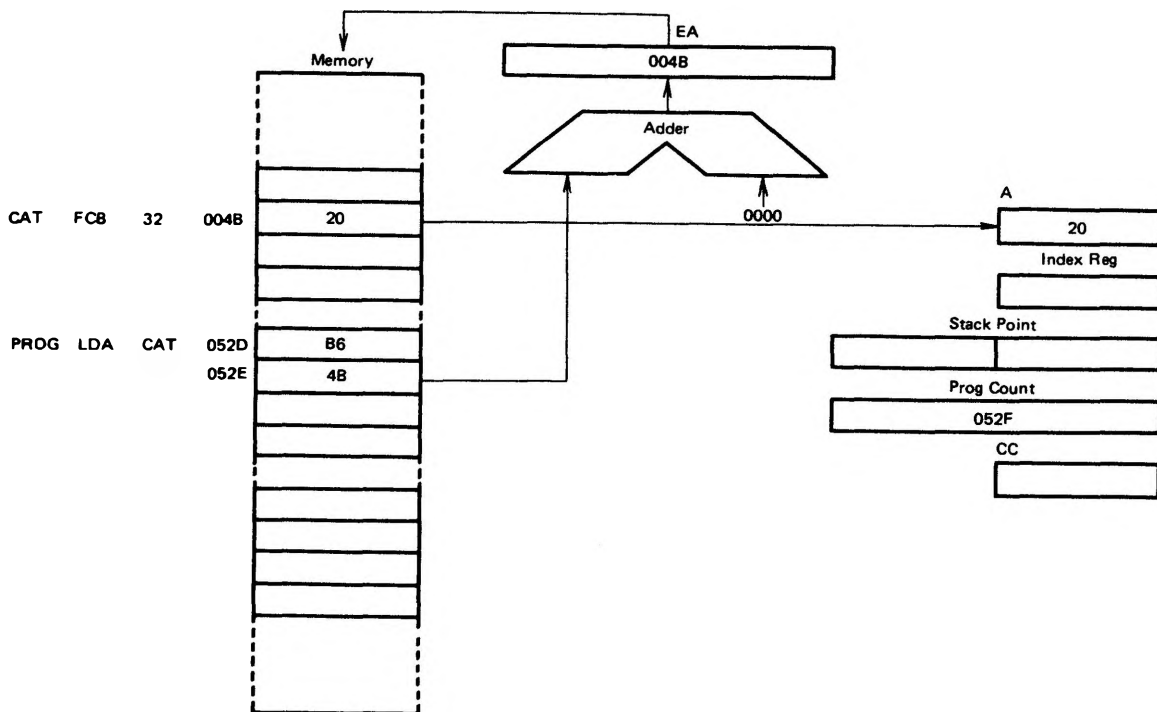


Figure 15 Direct Addressing Example

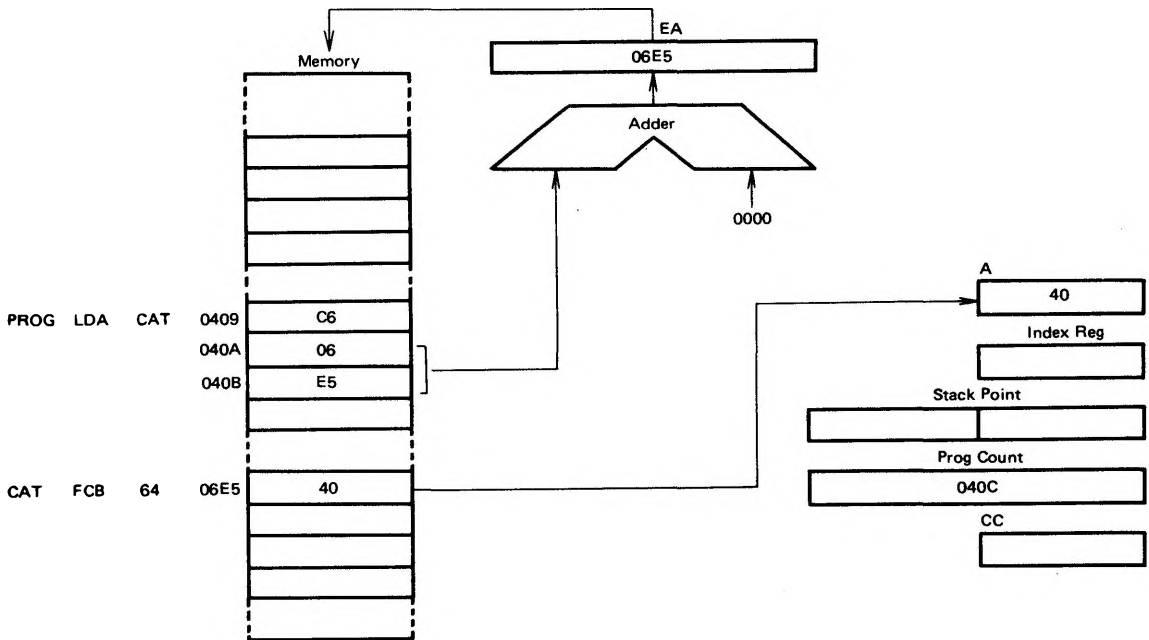


Figure 16 Extended Addressing Example

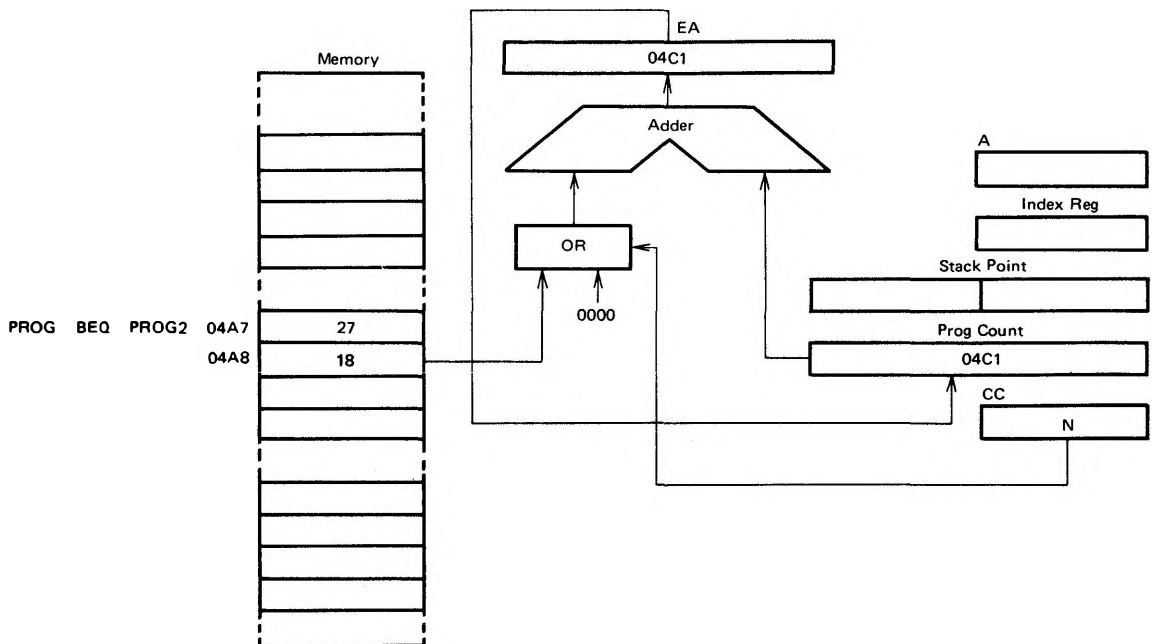


Figure 17 Relative Addressing Example

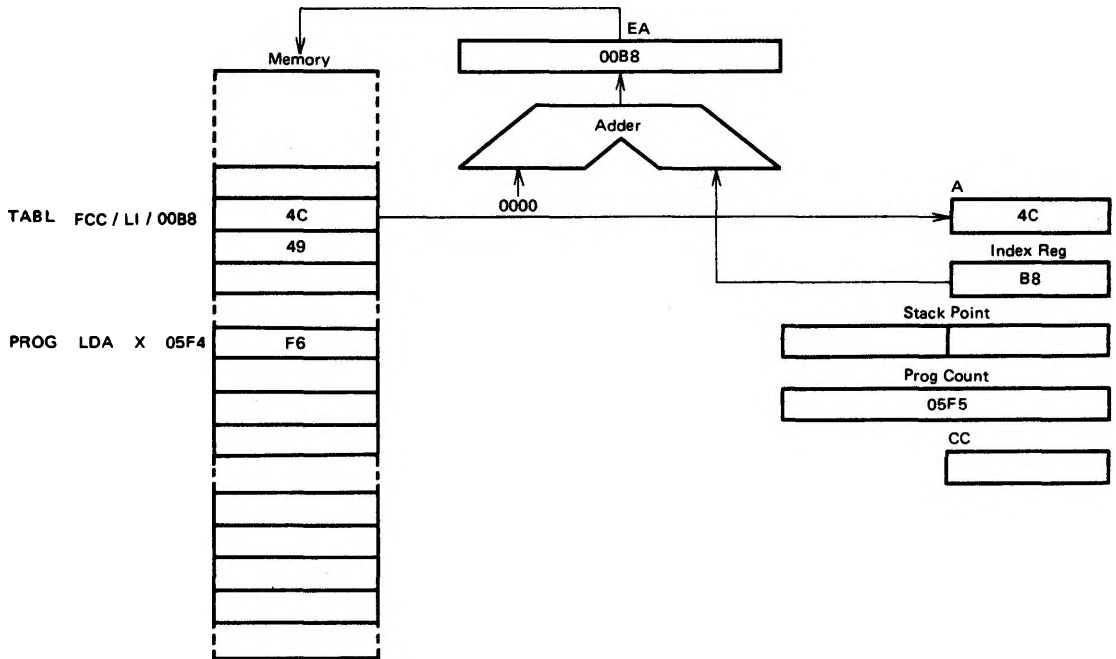


Figure 18 Indexed (No Offset) Addressing Example

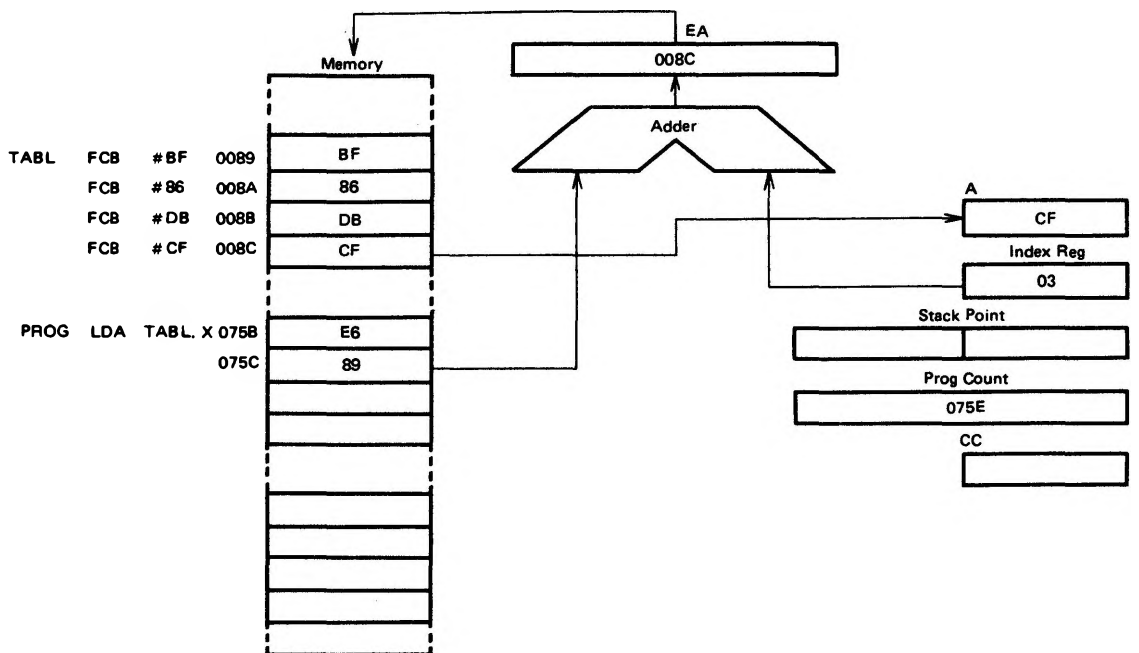


Figure 19 Indexed (8-Bit Offset) Addressing Example

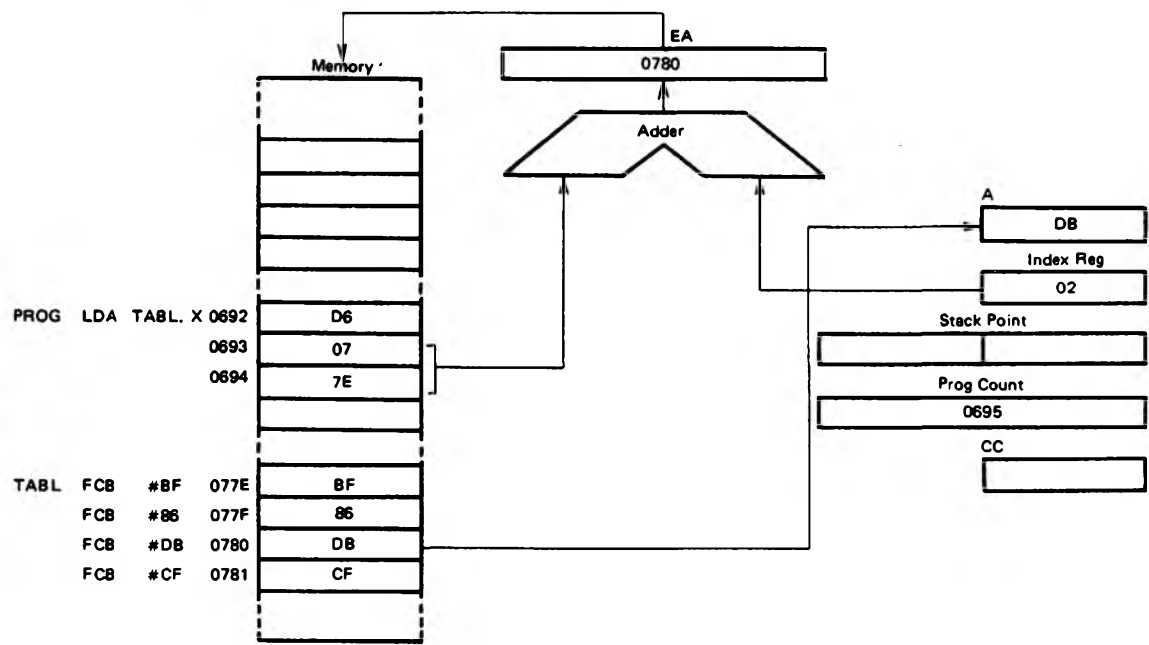


Figure 20 Indexed (16-Bit Offset) Addressing Example

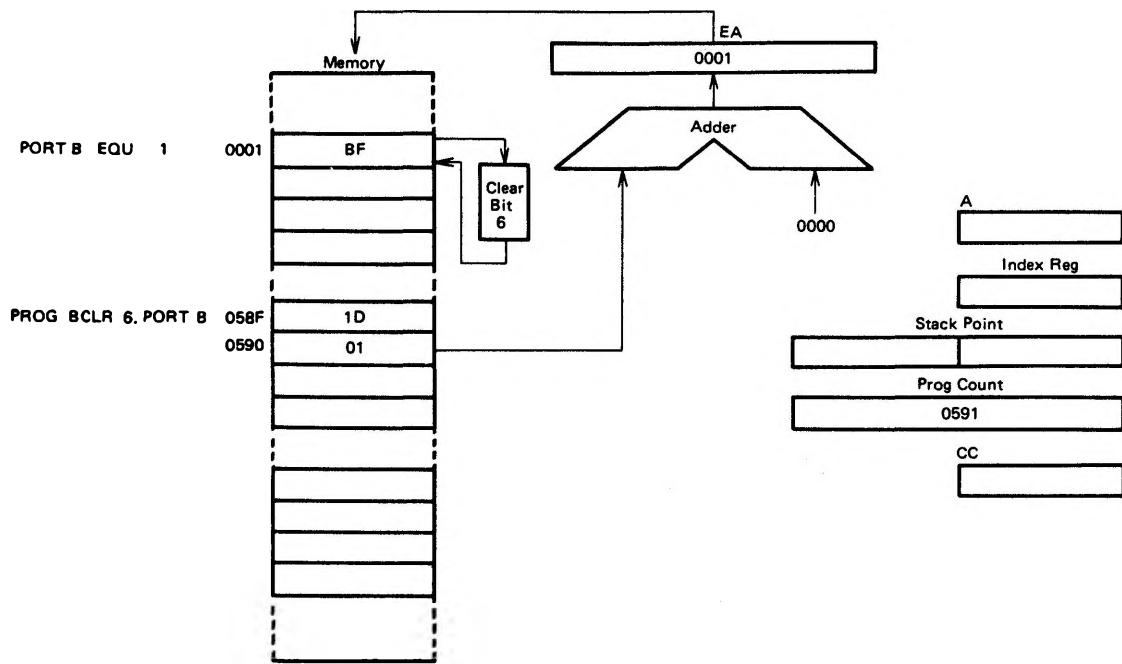


Figure 21 Bit Set/Clear Addressing Example

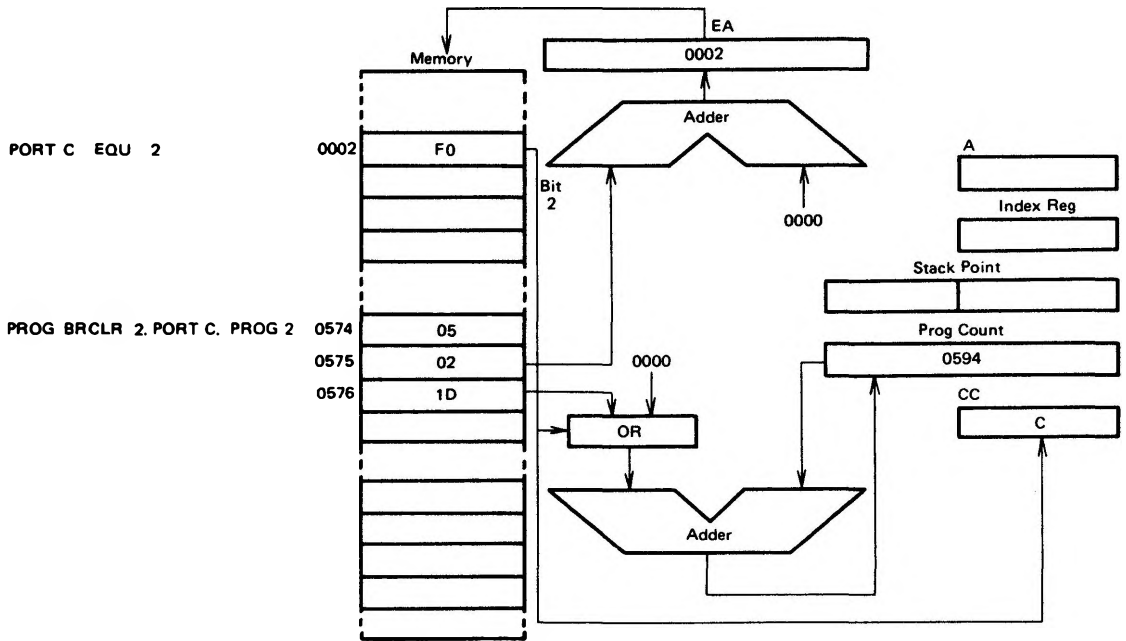


Figure 22 Bit Test and Branch Addressing Example

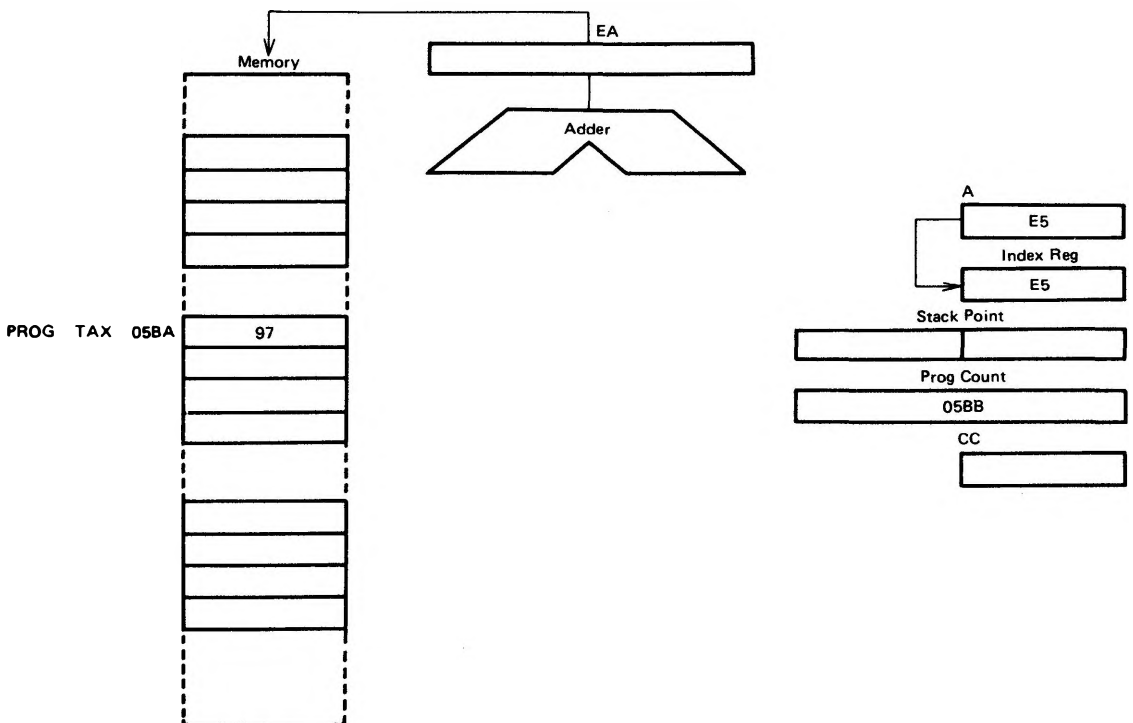


Figure 23 Implied Addressing Example

Table 4 Register/Memory Instructions

Function	Mnemonic	Addressing Modes																	
		Immediate			Direct			Extended			Indexed (No Offset)			Indexed (8-Bit Offset)			Indexed (16-Bit Offset)		
		Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles
Load A from Memory	LDA	A6	2	2	B6	2	4	C6	3	5	F6	1	4	E6	2	5	D6	3	6
Load X from Memory	LDX	AE	2	2	BE	2	4	CE	3	5	FE	1	4	EE	2	5	DE	3	6
Store A in Memory	STA	—	—	—	B7	2	5	C7	3	6	F7	1	5	E7	2	6	D7	3	7
Store X in Memory	STX	—	—	—	BF	2	5	CF	3	6	FF	1	5	EF	2	6	DF	3	7
Add Memory to A	ADD	A8	2	2	B8	2	4	CB	3	5	FB	1	4	EB	2	5	DB	3	6
Add Memory and Carry to A	ADC	A9	2	2	B9	2	4	C9	3	5	F9	1	4	E9	2	5	D9	3	6
Subtract Memory	SUB	A0	2	2	B0	2	4	C0	3	5	F0	1	4	E0	2	5	D0	3	6
Subtract Memory from A with Borrow	SBC	A2	2	2	B2	2	4	C2	3	5	F2	1	4	E2	2	5	D2	3	6
AND Memory to A	AND	A4	2	2	B4	2	4	C4	3	5	F4	1	4	E4	2	5	D4	3	6
OR Memory with A	ORA	AA	2	2	BA	2	4	CA	3	5	FA	1	4	EA	2	5	DA	3	6
Exclusive OR Memory with A	EOR	A8	2	2	B8	2	4	C8	3	5	F8	1	4	E8	2	5	D8	3	6
Arithmetic Compare A with Memory	CMP	A1	2	2	B1	2	4	C1	3	5	F1	1	4	E1	2	5	D1	3	6
Arithmetic Compare X with Memory	CPX	A3	2	2	B3	2	4	C3	3	5	F3	1	4	E3	2	5	D3	3	6
Bit Test Memory with A (Logical Compare)	BIT	A5	2	2	B5	2	4	C5	3	5	F5	1	4	E5	2	5	D5	3	6
Jump Unconditional	JMP	—	—	—	BC	2	3	CC	3	4	FC	1	3	EC	2	4	DC	3	5
Jump to Subroutine	JSR	—	—	—	BD	2	7	CD	3	8	FD	1	7	ED	2	8	DD	3	9

Table 5 Read/Modify/Write Instructions

Function	Mnemonic	Addressing Modes														
		Implied (A)			Implied (X)			Direct			Indexed (No Offset)			Indexed (8-Bit Offset)		
		Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles
Increment	INC	4C	1	4	5C	1	4	3C	2	6	7C	1	6	6C	2	7
Decrement	DEC	4A	1	4	5A	1	4	3A	2	6	7A	1	6	6A	2	7
Clear	CLR	4F	1	4	5F	1	4	3F	2	6	7F	1	6	6F	2	7
Complement	COM	43	1	4	53	1	4	33	2	6	73	1	6	63	2	7
Negate (2's Complement)	NEG	40	1	4	50	1	4	30	2	6	70	1	6	60	2	7
Rotate Left Thru Carry	ROL	49	1	4	59	1	4	39	2	6	79	1	6	69	2	7
Rotate Right Thru Carry	ROR	46	1	4	56	1	4	36	2	6	76	1	6	66	2	7
Logical Shift Left	LSL	48	1	4	58	1	4	38	2	6	78	1	6	68	2	7
Logical Shift Right	LSR	44	1	4	54	1	4	34	2	6	74	1	6	64	2	7
Arithmetic Shift Right	ASR	47	1	4	57	1	4	37	2	6	77	1	6	67	2	7
Arithmetic Shift Left	ASL	48	1	4	58	1	4	38	2	6	78	1	6	68	2	7
Test for Negative or Zero	TST	4D	1	4	5D	1	4	3D	2	6	7D	1	6	6D	2	7

Table 6 Branch Instructions

Function	Mnemonic	Relative Addressing Mode		
		Op Code	# Bytes	# Cycles
Branch Always	BRA	20	2	4
Branch Never	BRN	21	2	4
Branch IF Higher	BHI	22	2	4
Branch IF Lower or Same	BLS	23	2	4
Branch IF Carry Clear	BCC	24	2	4
(Branch IF Higher or Same)	(BHS)	24	2	4
Branch IF Carry Set	BCS	25	2	4
(Branch IF Lower)	(BLO)	25	2	4
Branch IF Not Equal	BNE	26	2	4
Branch IF Equal	BEQ	27	2	4
Branch IF Half Carry Clear	BHCC	28	2	4
Branch IF Half Carry Set	BHCS	29	2	4
Branch IF Plus	BPL	2A	2	4
Branch IF Minus	BMI	2B	2	4
Branch IF Interrupt Mask Bit is Clear	BMC	2C	2	4
Branch IF Interrupt Mask Bit is Set	BMS	2D	2	4
Branch IF Interrupt Line is Low	BIL	2E	2	4
Branch IF Interrupt Line is High	BIH	2F	2	4
Branch to Subroutine	BSR	AD	2	8

Table 7 Bit Manipulation Instructions

Function	Mnemonic	Addressing Modes					
		Bit Set/Clear			Bit Test and Branch		
		Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles
Branch IF Bit n is set	BRSET n (n=0 7)	—	—	—	2·n	3	10
Branch IF Bit n is clear	BRCLR n (n=0 7)	—	—	—	01+2·n	3	10
Set Bit n	BSET n (n=0 7)	10+2·n	2	7	—	—	—
Clear bit n	BCLR n (n=0 7)	11+2·n	2	7	—	—	—

Table 8 Control Instructions

Function	Mnemonic	Implied		
		Op Code	# Bytes	# Cycles
Transfer A to X	TAX	97	1	2
Transfer X to A	TXA	9F	1	2
Set Carry Bit	SEC	99	1	2
Clear Carry Bit	CLC	98	1	2
Set Interrupt Mask Bit	SEI	9B	1	2
Clear Interrupt Mask Bit	CLI	9A	1	2
Software Interrupt	SWI	83	1	11
Return from Subroutine	RTS	81	1	6
Return from Interrupt	RTI	80	1	9
Reset Stack Pointer	RSP	9C	1	2
No-Operation	NOP	9D	1	2

Table 9 Instruction Set

Mnemonic	Addressing Modes										Condition Code				
	Implied	Immediate	Direct	Extended	Relative	Indexed (No Offset)	Indexed (8 Bits)	Indexed (16 Bits)	Bit Set/Clear	Bit Test & Branch	H	I	N	Z	C
ADC		x	x	x		x	x	x			^	•	^	^	^
ADD		x	x	x		x	x	x			^	•	^	^	^
AND		x	x	x		x	x	x			•	•	^	^	•
ASL	x		x			x	x				•	•	^	^	^
ASR	x		x			x	x				•	•	^	^	^
BCC					x						•	•	•	•	•
BCLR									x		•	•	•	•	•
BCS					x						•	•	•	•	•
BEQ					x						•	•	•	•	•
BHCC					x						•	•	•	•	•
BHCS					x						•	•	•	•	•
BHI					x						•	•	•	•	•
BHS					x						•	•	•	•	•
BIH					x						•	•	•	•	•
BIL					x						•	•	•	•	•
BIT		x	x	x		x	x	x			•	•	^	^	•
BLO					x						•	•	•	•	•
BLS					x						•	•	•	•	•
BMC					x						•	•	•	•	•
BMI					x						•	•	•	•	•
BMS					x						•	•	•	•	•
BNE					x						•	•	•	•	•
BPL					x						•	•	•	•	•
BRA					x						•	•	•	•	•
BRN					x						•	•	•	•	•
BRCLR										x	•	•	•	•	^
BRSET										x	•	•	•	•	^
BSET									x		•	•	•	•	•
BSR					x						•	•	•	•	•
CLC	x										•	•	•	•	0
CLI	x										•	0	•	•	•
CLR	x		x			x	x				•	•	0	1	•
CMP		x	x	x		x	x	x			•	•	^	^	^
COM	x		x			x	x				•	•	^	^	1
CPX		x	x	x		x	x	x			•	•	^	^	^
DEC	x		x			x	x				•	•	^	^	•
EOR		x	x	x		x	x	x			•	•	^	^	•
INC	x		x			x	x				•	•	^	^	•
JMP			x	x		x	x	x			•	•	•	•	•
JSR			x	x		x	x	x			•	•	•	•	•
LDA		x	x	x		x	x	x			•	•	^	^	•
LDX		x	x	x		x	x	x			•	•	^	^	•

Condition Code Symbols:

H Half Carry (From Bit 3)
I Interrupt Mask
N Negative (Sign Bit)
Z Zero

C Carry Borrow
^ Test and Set if True, Cleared Otherwise
• Not Affected

(to be continued)

Table 9 Instruction Set

Mnemonic	Addressing Modes										Condition Code				
	Implied	Imme- diate	Direct	Ex- tended	Re- lative	Indexed (No Offset)	Indexed (8 Bits)	Indexed (16 Bits)	Bit Set/ Clear	Bit Test & Branch	H	I	N	Z	C
LSL	x		x			x	x				●	●	^	^	^
LSR	x		x			x	x				●	●	0	^	^
NEG	x		x			x	x				●	●	^	^	^
NOP	x										●	●	●	●	●
ORA		x	x	x		x	x	x			●	●	^	^	●
ROL	x		x			x	x				●	●	^	^	^
ROR	x		x			x	x				●	●	^	^	^
RSP	x										●	●	●	●	●
RTI	x										?	?	?	?	?
RTS	x										●	●	●	●	●
SBC		x	x	x		x	x	x			●	●	^	^	^
SEC	x										●	●	●	●	1
SEI	x										●	1	●	●	●
STA			x	x		x	x	x			●	●	^	^	●
STX			x	x		x	x	x			●	●	^	^	●
SUB		x	x	x		x	x	x			●	●	^	^	^
SWI	x										●	1	●	●	●
TAX	x										●	●	●	●	●
TST	x		x			x	x				●	●	^	^	●
TXA	x										●	●	●	●	●

Condition Code Symbols:

H Half Carry (From Bit 3)
 I Interrupt Mask
 N Negative (Sign Bit)
 Z Zero

C Carry/Borrow
 ^ Test and Set if True, Cleared Otherwise
 ● Not Affected
 ? Load CC Register From Stack

Table 10 Opcode Map

Bit Manipulation		Branch	Read/Modify/Write					Control		Register/Memory							
Test & Branch	Set/ Clear	Rel	DIR	A	X	X1	X0	IMP	IMP	IMM	DIR	EXT	X2	X1	X0	← HIGH	
0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F		
0	BRSET0	BSET0	BRA	NEG				RTI*	—	SUB						0	
1	BRCLR0	BCLR0	BRN	—				RTS*	—	CMP						1	
2	BRSET1	BSET1	BHI	—				—	—	SBC						2	
3	BRCLR1	BCLR1	BLS	COM				SWI*	—	CPX						3 L	
4	BRSET2	BSET2	BCC	LSR				—	—	AND						4 O	
5	BRCLR2	BCLR2	BCS	—				—	—	BIT						5 W	
6	BRSET3	BSET3	BNE	ROR				—	—	LDA						6	
7	BRCLR3	BCLR3	BEQ	ASR				—	TAX	—	STA(+1)						7
8	BRSET4	BSET4	BHCC	LSL/ASL				—	CLC	EOR						8	
9	BRCLR4	BCLR4	BHCS	ROL				—	SEC	ADC						9	
A	BRSET5	BSET5	BPL	DEC				—	CLI	ORA						A	
B	BRCLR5	BCLR5	BMI	—				—	SEI	ADD						B	
C	BRSET6	BSET6	BMC	INC				—	RSP	—	JMP(−1)						C
D	BRCLR6	BCLR6	BMS	TST				—	NOP	BSR*	JSR(−3)						D
E	BRSET7	BSET7	BIL	—				—	—	LDX						E	
F	BRCLR7	BCLR7	BIH	CLR				—	TXA	—	STX(+1)						F
3/10		2/7	2/4	2/6	1/4	1/4	2/7	1/6	1/*	1/2	2/2	2/4	3/5	3/6	2/5	1/4	

- (NOTE) 1. Undefined opcodes are marked with "—".
2. The number at the bottom of each column denote the number of bytes and the number of cycles required (Bytes/Cycles). Mnemonics followed by a "*" require a different number of cycles as follows:
RTI 9
RTS 6
SWI 11
BSR 8
3. () indicate that the number in parenthesis must be added to the cycle count for that instruction.

■ HD68P05V USED FOR HD6805U/V

Fig. 25 provides the memory configuration of MCU. Fig. 25(a) provides the configuration of HD68P05V used for HD6805U. "Not Used" memory map may be used for HD68P05V but not used for HD6805U. If used for HD6805V, HD68P05V will have the configuration shown in Fig. 25(b).

The timer part of HD6805U/V is mask-option. If used for HD6805U/V, HD68P05V sets the bit 0 to 5 of timer control

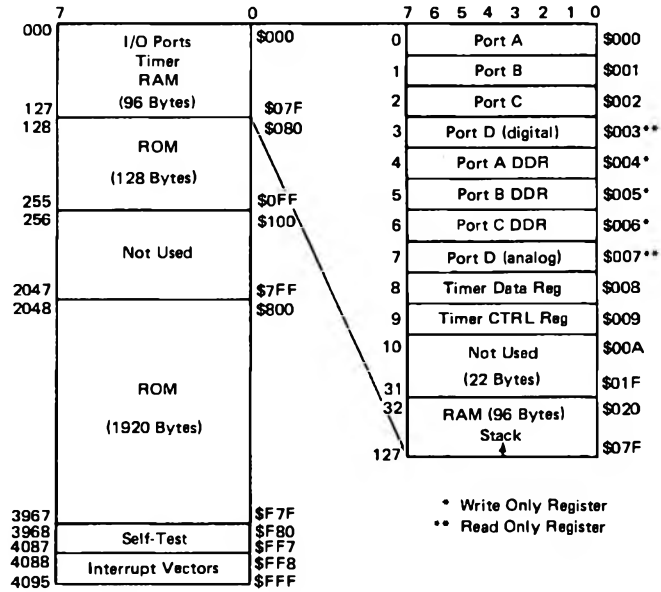
register in the program just after reset and selects the dividing ratio of the prescaler and the clock input source. Fig. 24 shows an example of the program which selects the external clock as an input source at 128 dividing.

If the program specified by the HD68P05V is masked as HD6805U/V, the command to operate this bit is ignored because HD6805U/V doesn't have the bit 0 to 5 of the timer control register.

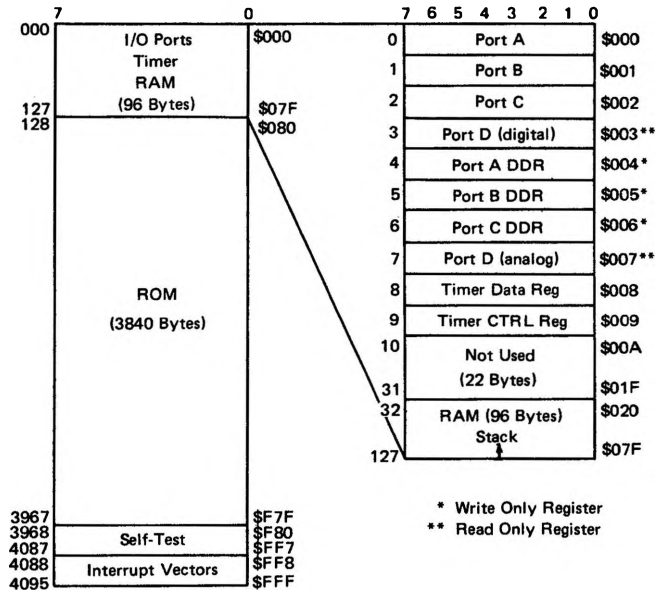
```
LDA #$77
STA TCR ($009)
```



Figure 24 Example to initialize timer control register (TCR)



(a) HD6805U Configuration



(b) HD6805V Configuration

Figure 25 MCU Memory Configuration